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FDS9431A-F085

P-Channel 2.5V Specified MOSFET

General Description

This P-Channel 2.5V specified MOSFET is produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize onstate resistance and yet maintain superior switching performance.

ApplicationsDC/DC converter

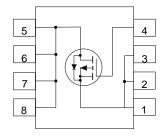
- · Power management
- Load switch
- Battery protection

Features

- -3.5 A, -20 V. $R_{DS(ON)} = 0.130 \Omega$ @ $V_{GS} = -4.5 V$ $R_{_{DS(ON)}} = 0.180~\Omega~$ @ $V_{_{GS}} =~-2.5~V.$
- · Fast switching speed.
- High density cell design for extremely low R_{DS(ON)}.
- · High power and current handling capability.
- Qualified to AEC Q101
- RoHS Compliant







Absolute Maximum Ratings

T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V_{DSS}	Drain-Source Voltage		-20	V	
V_{GSS}	Gate-Source Voltage		±8	V	
I _D	Drain Current - Continuous	(Note 1a)	-3.5	Α	
	- Pulsed		-18		
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W	
		(Note 1b)	1.2		
		(Note 1c)	1.0		
T _J , T _{stg}	Operating and Storage Junction Temperat	ure Range	-55 to +150	°C	

Thermal Characteristics

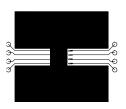
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity	
FDS9431A	FDS9431A-F085	13"	12mm	2500 units	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics			•		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A,Referenced to 25°C		-28		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V			-1	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 8 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -8 V, V _{DS} = 0 V			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	-0.6	-1	V
$\Delta V_{GS(th)} \over \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	I_D = -250 μ A,Referenced to 25°C		2		mV/°C
R _{DS(on)}	Static Drain-Source	$V_{GS} = -4.5 \text{ V}, I_{D} = -3.5 \text{ A}$		0.110	0.130	Ω
	On-Resistance	$V_{GS} = -2.5 \text{ V}, I_{D} = -3.0 \text{ A}$ $V_{GS} = -4.5 \text{ V}, I_{D} = -3.5 \text{ A}$		0.140 0.155	0.180 0.220	Ω
		T _J =125°C		0.133	0.220	Ω
I _{D(on)}	On-State Drain Current	V _{GS} = -4.5 V, V _{DS} =-5 V	-10			Α
g FS	Forward Transconductance	$V_{DS} = -5 \text{ V}, I_{D} = -3.5 \text{ A}$		6.5		S
Dvnamio	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$		405		pF
Coss	Output Capacitance	f = 1.0 MHz		170		pF
Crss	Reverse Transfer Capacitance	7		45		pF
Switchir	g Characteristics (Note 2)	•		•		•
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -5 \text{ V}, I_{D} = -1 \text{ A},$		6.5	13	ns
t _r	Turn-On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		20	35	ns
t _{d(off)}	Turn-Off Delay Time	7		31	50	ns
t _f	Turn-Off Fall Time	7		21	35	ns
Qg	Total Gate Charge	$V_{DS} = -5 \text{ V}, I_{D} = -3.5 \text{ A},$		6	8.5	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -4.5 V		0.8		nC
Q _{gd}	Gate-Drain Charge	7		1.3		nC
Drain-Sc	ource Diode Characteristics a	and Maximum Ratings			•	•
Is		us Drain-Source Diode Forward Current			-2.1	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -2.1 \text{ A} \text{ (Note 2)}$		-0.7	-1.2	V

^{1:} R_{6JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 50° C/W when mounted on a 1 in² pad of 2 oz. copper.



b) 105° C/W when mounted on a 0.04 in² pad of 2 oz. copper.

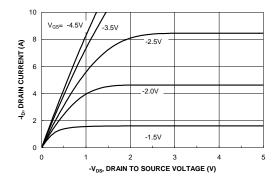


c) 125° C/W on a minimum mounting pad.

Scale 1: 1 on letter size paper

2: Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

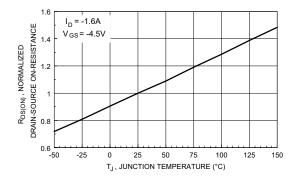
Typical Characteristics



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Figure 1. On-Region Characteristics.

Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.



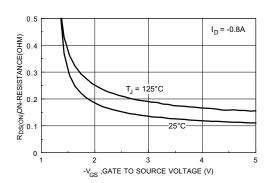
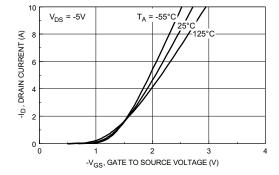


Figure 3. On-Resistance Variation with Temperature.

Figure 4. On-Resistance Variation with Gate-to-Source Voltage.



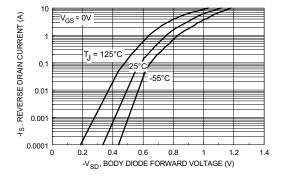


Figure 5. Transfer Characteristics.

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics (continued)

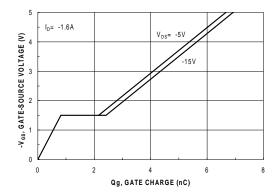
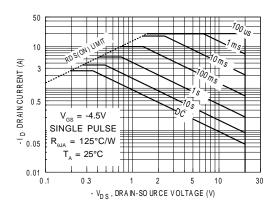


Figure 7. Gate Charge Characteristics.

Figure 8. Capacitance Characteristics.



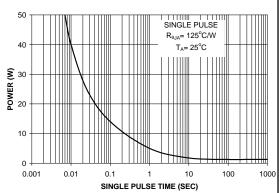


Figure 9. Maximum Safe Operating Area.

Figure 10. Single Pulse Maximum Power Dissipation.

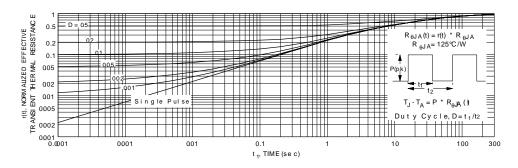


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient themal response will change depending on the circuit board design.

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